

CKC21X103JCGAC7210

KC-LINK Auto COG, Ceramic, 0.01 uF, 5%, 500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 2220



Click here for the 3D model.

Dimensions	
Chip Size	2220
L	6.1mm +/-0.75mm
W	5mm +/-0.4mm
Т	2mm +/-0.20mm
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 330mm, Plastic Tape
Packaging Quantity	2000
5 5	

General Information	
Series	KC-LINK Auto COG
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra-Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
Qualifications	AEC-Q200
AEC-Q200	Yes
Component Weight	260 mg
Shelf Life	78 Weeks
MSL	1

Specifications			
Capacitance	0.01 uF		
Measurement Condition	1 kHz 1.0Vrms		
Capacitance Tolerance	5%		
Voltage DC	500 VDC		
Dielectric Withstanding Voltage	750 VDC		
Temperature Range	-55/+150°C		
Temperature Coefficient	COG		
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms		
Dissipation Factor	0.1% 1 kHz 1.0Vrms		
Aging Rate	0% Loss/Decade Hour		
Insulation Resistance	100 GOhms		

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